Electronic Supplementary Information for

## Quantitative analysis of bending hysteresis by real-time monitoring of curvature in flexible polymeric films

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Fig. S1. Stress-strain (S-S) curves of uniaxial mechanical testing to 0.5% (blue), 1.0% (sky blue), 1.5% (green), 2.0% (yellow), 2.5% (orange) and 3.0% (red) strains.



Fig. S2. (a) S-S curve upon loading. Experimental and fitting curves correspond to solid and dotted lines, respectively. (b) The slope (blue) and intercept (red) of unloading S-S curves as a function of turnaround strain.



Fig. S3. Internal stresses in the thickness direction of the bent PEN film with thicknesses of 100  $\mu$ m (a) and 75  $\mu$ m (e) by various applied strains. A model of the bending film with thicknesses of 100  $\mu$ m (b) and 75  $\mu$ m (f) at the applied strain of 55%. The bent film has vertical cross-section that is perpendicular to the material axis. Internal stress distribution of the PEN film with thicknesses of 100  $\mu$ m (c) and 75  $\mu$ m (g) upon bending with the applied strain of 55%. Internal stress distribution of the PEN film with thicknesses of 100  $\mu$ m (d) and 75  $\mu$ m (h) upon bending with the applied strain of 55% at turnaround applied strains of 85%, 80%, 75% and 70%.